



## VERIFICATION OF TRANSLATION

RE: Piezoelectric Vibration Piece, Piezoelectric Device using  
Piezoelectric Vibration Piece, Portable Phone Unit using  
Piezoelectric Device, and Electronic Equipment using  
Piezoelectric Device

I, Michio Ogawa, Ark Mori Bldg., 13F, No. 12-32, Akasaka 1-chome,  
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Piezoelectric Vibration Piece, Piezoelectric Device using  
Piezoelectric Vibration Piece, Portable Phone Unit using  
Piezoelectric Device, and Electronic Equipment using Piezoelectric  
Device

and I state that the following is a true translation to the best of my  
knowledge and belief.

(Signature of Translator) Michio Ogawa

(Date) January 6, 2004



#### Description

Piezoelectric Vibration Piece, Piezoelectric Device using  
Piezoelectric Vibration Piece, Portable Phone Unit using  
Piezoelectric Device, and Electronic Equipment using Piezoelectric  
Device

#### Technical Field

[0001]

The present invention relates to a piezoelectric vibration piece, a piezoelectric device accommodating the piezoelectric vibration piece in its package, and a portable phone and electronic equipment using the piezoelectric device.

#### Related Art

[0002]

In small-sized information equipment such as HDDs (Hard Disk Drive), mobile computers, or IC cards, and mobile communications devices such as portable phones, car phones, or paging systems, widely used are piezoelectric devices such as piezoelectric vibrators and piezoelectric oscillators each accommodating a piezoelectric vibration piece in their packages.

[0003]

FIG. 11 is a schematic cross-sectional view showing an exemplary structure of such a piezoelectric device.

[0004]

In the drawing, a piezoelectric device 1 is accommodating a piezoelectric vibration piece 3 in its package 2. In this case, the package 2 is formed in a shape of shallow box made by an insulation material, and the internally-accommodated piezoelectric vibration piece 3 is securely fixed therein before the package is sealed by a lid body 4.

[0005]

The package 2 is formed by mold-laminating a plurality of substrates 2a, 2b, and 2c each being a ceramic green sheet before subjected to sintering. Inside of the substrates 2b and 2c, a hole is each formed by eliminating the material at the time of substrate formation. Thereby, as shown in the drawing, formed is a space for accommodating the piezoelectric vibration piece 3.

[0006]

The piezoelectric vibration piece 3 is exemplarily formed as shown in FIG. 12 by crystal etching. As shown in the drawing, the piezoelectric vibration piece 3 is structured by, so-called, a crystal piece of a tuning fork type including a base section 5, and a pair of vibration arms 6 and 7 horizontally extending from the base section 5 in the right direction in the drawing.

[0007]

The vibration arms 6 and 7 are formed, respectively, with grooves 6a and 7a extending in the length direction. FIG. 13 shows the cross-sectional view of this vibration arm 7 cut along B-B line. As shown in FIG. 13, excitation electrodes 8a and 8b are formed, and

with respect to these excitation electrodes 8a and 8b, a driving voltage is externally applied. As a result, as shown by arrows of FIG. 13, the vibration arm 7 is internally formed with an electric field as shown by the arrows. By the action of such an electric field, with respect to the vibration arms 6 and 7 of FIG. 12, the both sides of each of the grooves 6a and 7a repeatedly expands and contracts as indicated by the arrows.

[0008]

Thereby, as shown in FIG. 12, the vibration arms 6 and 7 vibrate so that the tip sides thereof come near or apart as shown by an arrow A. Note here that, in FIG. 12, the shown movement of the vibration arms 6 and 7 is extremely exaggerated than the actual movement for convenience of understanding. Extracting the vibration frequency based on such vibration enables application to various signals exemplified by a control clock signal and the like.

[0009]

Here, the vibration of the vibration arms 6 and 7 along the arrow A of FIG. 12 is the horizontal movement along the direction of arrow x of FIG. 13 (hereinafter, this direction is referred to as "horizontal direction").

[0010]

[Patent Document 1] JP-A-56-65517

[0011]

The issue here is that, in FIG. 13, in the manufacturing process of forming the grooves 7a and 7a to the surface and back

sides of the vibration arm 7, the grooves 7a and 7a are formed by half etching from the surface side and the back side of the vibration arm 7. To the vibration arm 7 having the arm width of only about 100  $\mu\text{m}$ , the grooves 7a and 7a formed to the surface side and the back side as such are separately formed from the surface and back sides of the vibration arm 7. Thus, as shown in FIG. 13, in the drawing, they are sometimes deviated from each other in the right and left directions, respectively.

[0012]

In such a state, as shown in FIG. 12, when the vibration arms 6 and 7 vibrate in the direction of arrow A, the resulting movement is added with the movement of a component in the z direction of FIG. 13 (in the below, this direction is referred to as "vertical direction"). The resulting vibration becomes the one directed in the direction of arrow C.

[0013]

Such a vibration property change causes various harmful effects, and as examples, FIG. 14 shows the interrelation between the temperature change and the frequency shift of the piezoelectric vibration piece 3 when the vibration arms 6 and 7 vibrate correctly in the direction of arrow A, and FIG. 15 shows the interrelation between the temperature change and the frequency shift of the piezoelectric vibration piece 3 when the vibration arms 6 and 7 vibrate with the movement of the vertical component as described by referring to FIG. 13.

[0014]

That is, a frequency  $f$  is expressed by the following equation, where  $k$  denotes a constant,  $E$  denotes an elastic constant, and  $I$  denotes a geometrical moment of inertia.

$$f = k \cdot (E \cdot I)^{-2} \dots\dots \text{equation 1}$$

[0015]

Therefore, the temperature property will look like a secondary curve responding to the change of the elastic constant and the elastic secondary moment.

[0016]

With a comparative study of the temperature property of such a piezoelectric vibration piece 3, in the case of FIG. 14, the maximum temperature with the frequency change is normal and in the close range of 25 degrees centigrade, and in the case of FIG. 15, the temperature is shifted to the negative side and about 14 degrees centigrade.

[0017]

An object of the present invention is to provide a piezoelectric vibration piece achievable with appropriate vibration, a piezoelectric device utilizing the piezoelectric vibration piece by suppressing the movement of vibration arms in the vertical direction and by ensuring the rigidity along the almost entire length of the vibration arms, and a portable phone and electronic equipment using the piezoelectric device.

## Summary of the Invention

[0018]

According to the first invention, the above-described object is achieved by a piezoelectric vibration piece that is including: a pair of vibration arms that are formed by a piezoelectric material, and are extending in the horizontal direction from a base section; a groove with a bottom that is each provided to the vibration arms, and are extending along the length direction of the corresponding vibration arm; and a support section that is provided in such a manner so as to across the groove in the width direction to integrally connect the material structuring the vibration arm separated by the groove in the width direction.

[0019]

According to the structure of the first invention, the groove provided to each of the vibration arms is a groove with a bottom. Thus, in comparison with the case of forming a penetrated groove to each of the vibration arms, these vibration arms will have the better rigidity. Further, to each of the grooves, provided is the support section formed so as to across the groove in the width direction to integrally connect the material structuring the vibration arm separated by the groove in the width direction. With such a structure, the support section becomes integrated, in structure, especially with the bottom section of the groove to support the material structuring the vibration arm separated by the groove in the width direction, thereby preventing distortion from occurring. As a

result, the better rigidity can be achieved in the twisting direction of the corresponding vibration arm.

[0020]

As such, according to the present invention, there is no more need to provide the support section plurally to the vibration arm. Thus, such effects as obtaining a piezoelectric vibration piece realizable with appropriate vibration can be exerted by ensuring the rigidity along the almost entire length of the vibration arm with the movement of the vibration arm suppressed in the vertical direction.

[0021]

The second invention is characterized in that, in the structure of the first invention, an integral section being integrated with the bottom section of the groove of the support section is formed so as to be thicker than at least an end section located on an opening side of the groove of the support section.

[0022]

According to the structure of the second invention, the integral section being integrated with the bottom section of the groove of the support section is formed so as to be thicker than at least the end section located on the opening side of the groove of this support section. In other words, the support section is formed in such a manner so as to increase its thickness toward the bottom section of the groove. Therefore, the support section is securely connected especially to the bottom section of this groove. Accordingly, through such a secure fixation of the support section to



the bottom section of this groove, in the piezoelectric vibration piece, the deformation force in the twisting direction of the vibration arms can be effectively dealt with. Thereby, the deformation in the twisting direction can be prevented from occurring in a more effective manner.

[0023]

The third invention is characterized in that, in either structure of the first or second invention, the groove is provided to a surface side and a back side of each of the vibration arms.

[0024]

According to the structure of the third invention, each of the vibration arms is formed with the groove in its surface and back sides. Thus, groove formation with a fine width to the narrow vibration arm sometimes deviates the groove position on the surface side from that on the back side. However, paying attention to the fact that such a groove with a bottom exerts considerable effects in terms of rigidity enforcement of the vibration arms, inventors of the present invention is accepting such a process drawback as groove deviation between the surface and back sides, and if any harmful effects are caused thereby, they are solving those by forming the support section to each of the grooves on both the surface and back sides. That is, providing a groove with a bottom section together with forming the support section to each of the grooves on the surface and back sides can effectively suppress the movement of the vertical component of each of the vibration arms.

[0025]

A fourth invention is characterized in that, in the structure of any one of the first to third inventions, the support section is plurally formed to one of the grooves.

[0026]

According to the structure of the fourth invention, a CI (Crystal Impedance) value is increased as the number of the support section formed to one groove is increased. Increasing the number of the support section as such, the vibration arms can be improved in rigidity thereby.

[0027]

A fifth invention is characterized in that, in the structure of any one of the first to fourth inventions, each of the vibration arms has the arm width being in a range from 50  $\mu\text{m}$  to 150 $\mu\text{m}$ , and the depth of the groove being 30 percent or more but less than 50 percent of the material thickness of each of the vibration arms.

[0028]

According to the structure of the fifth invention, when the arm width of the respective vibration arms is in a range from 50  $\mu\text{m}$  to 150  $\mu\text{m}$ , assuming that the depth of the groove is less than 30 percent of the material thickness of each of the vibration arms, the reduction effects for the CI value cannot be enough. Thereby the CI value fails to be practical. Further, if the depth of the groove exceeds 50 percent of the material thickness of the respective vibration arms, groove formation to the surface and back sides of the

corresponding vibration arm becomes impossible.

[0029]

A sixth invention is characterized in that, in the structure of any one of the structures of the first to fifth inventions, the groove width of the groove provided to each of the vibration arms is 40 percent or more of the arm width of the corresponding vibration arm.

[0030]

According to the structure of the sixth invention, with 40 percent or more of the arm width of the vibration arm, achieved are such effects that the CI value can be appropriately controlled, so that the practical CI value can be realized.

[0031]

A seventh invention is characterized in that, in the structure of the sixth invention, the groove width of the groove provided to each of the vibration arms is 70 percent or more of the arm width of the corresponding vibration arm.

[0032]

According to the structure of the seventh invention, with 70 percent or more of the arm width of the vibration arm, the CI value can be suppressed in the most effective manner, and with or close to 100 percent of the arm width of the vibration arm, groove formation to the vibration arm becomes impossible.

[0033]

The above-described object is achieved by a piezoelectric

device accommodating a piezoelectric vibration piece in its case or package, and the piezoelectric vibration piece includes: a pair of vibration arms extending in a horizontal direction from a base section; a groove with a bottom that is provided to each of the vibration arms, and is extending along the length direction of each of the vibration arms; and a support section provided so as to across the groove in the width direction to integrally connect the material structuring the vibration arm separated by the groove in the width direction.

[0034]

According to the eighth invention, to each of the vibration arms of the piezoelectric vibration piece accommodated in this piezoelectric device, a groove with a bottom is formed. The support section provided to the groove is, especially, structured to be integrated with the bottom section of the groove to support the material structuring the vibration arm separated by the groove in the width direction. With such a structure, deformation is prevented from occurring. Thus, rigidity enforcement can be achieved in the twisting direction of each of the vibration arms. As such, with respect to the piezoelectric vibration piece accommodated in the piezoelectric device, the rigidity is ensured along the almost entire length of the vibration arm with the movement of the vibration arms suppressed in the vertical direction, thereby realizing appropriate vibration.

[0035]

The above-described object is achieved by, according to a ninth invention, a portable phone unit utilizing a piezoelectric device that is accommodating a piezoelectric vibration piece in its case or package, and a clock signal is derived for control by the piezoelectric device in which the piezoelectric vibration piece includes: a pair of vibration arms extending in a horizontal direction from a base section; a groove with a bottom that is provided to each of the vibration arms, and is extending along the length direction of each of the vibration arms; and a support section provided so as to across the groove in the width direction to integrally connect the material structuring the vibration arm separated by the groove in the width direction.

[0036]

The above-described object is achieved by, according to a tenth invention, electronic equipment utilizing a piezoelectric device that is accommodating a piezoelectric vibration piece in its case or package, and a clock signal is derived for control by the piezoelectric device in which the piezoelectric vibration piece includes: a pair of vibration arms extending in a horizontal direction from a base section; a groove with a bottom that is provided to each of the vibration arms, and is extending along the length direction of each of the vibration arms; and a support section provided so as to across the groove in the width direction to integrally connect the material structuring the vibration arm separated by the groove in the width direction.

#### Brief Description of the Drawings

FIG. 1 is a schematic plan view showing an embodiment of a piezoelectric device of the present invention.

FIG. 2 is a schematic cross-sectional view cut along E-E line of FIG. 1.

FIG. 3 is a schematic perspective view showing the main section of a piezoelectric vibration piece to be used for the piezoelectric device of FIG. 1.

FIG. 4 is a cross-sectional view cut along F-F line of FIG. 3.

FIG. 5 is a graph showing the relationship between a frequency change ratio and a current based on an electrical field formed, at the time of driving, to the piezoelectric vibration piece whose vibration arm has no groove.

FIG. 6 is a graph showing the relationship between a frequency change ratio and a current based on an electrical field formed, at the time of driving, to the piezoelectric vibration piece whose vibration arm has a groove but no support section.

FIG. 7 is a graph showing the relationship between a frequency change ratio and a current based on an electrical field formed, at the time of driving, to the piezoelectric vibration piece of the present embodiment.

FIG. 8 is a graph showing the interrelation between a CI value and a temperature property as to the piezoelectric vibration piece of a so-called tuning fork type whose vibration arm has a groove but no

support section.

FIG. 9 is a graph showing the interrelation between a CI value and a temperature property as to the piezoelectric vibration piece of the present embodiment.

FIG. 10 is a diagram showing the schematic structure of a portable digital phone unit as exemplary electrical equipment utilizing the piezoelectric device according to the embodiment of the present invention.

FIG. 11 is a schematic cross-sectional view showing an exemplary conventional piezoelectric device.

FIG. 12 is a schematic plan view of a piezoelectric vibration piece to be used for the piezoelectric device of FIG. 11.

FIG. 13 is a cross-sectional view cut along B-B line of FIG. 12.

FIG. 14 is a graph showing the normal relationship between the frequency shift and the temperature property as to the piezoelectric vibration piece to be used for the piezoelectric device of FIG. 11.

FIG. 15 is a graph showing the fact that the unfavorable relationship is observed between the frequency shift and the temperature property as to the piezoelectric vibration piece to be used for the piezoelectric device of FIG. 11.

#### Best Mode for Carrying Out the Invention

[0037]

FIGS. 1 and 2 both show a first embodiment of a piezoelectric

device of the present invention. FIG. 1 is a schematic plan view thereof, and FIG. 2 is a schematic cross-sectional view cut along E-E line of FIG. 1.

[0038]

In the drawings, a piezoelectric device 30 is exemplarily structuring a piezoelectric vibrator, and the piezoelectric device 30 is accommodating a piezoelectric vibration piece 32 in its package 36. As an insulating material, the package 36 is formed, for example, by mold-laminating a plurality of substrates each being a ceramic green sheet made of aluminum oxide before subjected to sintering. Inside of each of the plurality of substrates is formed with a predetermined hole. Thus, after laminated, a predetermined inner space S2 is formed inside. In this embodiment, for the purpose of minimizing the thickness of the package 36, a first substrate 61 and a second substrate 62 are laminated together. By eliminating the material inside of the second substrate 62, the space of inner space S2 is formed.

[0039]

This inner space S2 is an accommodating space for accommodating the piezoelectric vibration piece.

[0040]

In the drawing showing the inner space S2 of the package 36, in the vicinity of the left end section, to the first substrate 61 structuring the inner bottom section by exposing to the inner space S2, provided are, for example, electrode sections 31 and 31 formed by



nickel plating or gold plating on tungsten metallization.

[0041]

These electrode sections 31 and 31 are connected to outside, and provided for supplying a driving voltage. Coated on the respective electrode sections 31 and 31 is conductive adhesive 43 and 43. On the conductive adhesive 43 and 43, mounted are extraction electrodes 33 and 33 provided to both end sections, in the width direction, of the base section 51 of the piezoelectric vibration piece 32. Thereby, the conductive adhesive 43 and 43 is hardened. Herein, as the conductive adhesive 43 and 43, used is the mixture as a result of mixing conductive particles such as silver fine particles to synthetic resin as an adhesive component exerting bonding force, and a possibility therefor is silicone, epoxy, or polyimide conductive adhesive and the like, for example.

[0042]

The piezoelectric vibration piece 32 is formed by crystal, for example, and other than that, used therefor is a piezoelectric material such as tantalic acid lithium, or lithium niobate. In the present embodiment, the piezoelectric vibration piece 32 is specifically small-sized in such a shape as shown in the drawing to derive any necessary capability.

[0043]

That is, the piezoelectric vibration piece 32 includes the base section 51 fixed to the side of the package 36 in the manner as will be described later. Also included are a pair of vibration arms

34 and 35 being bifurcated and extending parallel from this base section 51 to the right direction in the drawing. As such, used is a so-called tuning-fork type piezoelectric vibration piece which has a shape of tuning-folk like as a whole.

[0044]

The detailed structure of this piezoelectric vibration piece 32 will be described later in more detail.

[0045]

To an opened upper end of the package 36, a lid body 39 is coupled for sealing. The lid body 39 is formed by a light-transmission material, specifically, a thin-plate glass for, after sealingly fixed to the package 36, frequency adjustment by the mass reduction process after externally applying laser light LB to the metal-coated part of the piezoelectric vibration piece 32 or a part of the excitation electrode (not shown), as shown in FIG. 2.

[0046]

As a glass material suited for the lid body 39 is, for example, as a thin-plate glass to be manufactured by the downdraw process, for example, used is a borosilicate glass.

[0047]

By referring now to FIGS. 3 and 4, described in detail is the piezoelectric vibration piece 32 to be accommodated in the package 36 of the piezoelectric device 30.

[0048]

FIG. 3 is a schematic perspective view showing the structure

of the piezoelectric vibration piece 32, and FIG. 4 is a cross-sectional view cut along F-F line of FIG. 3 (a diagram showing only the cross-sectional plane).

[0049]

In FIG. 3, the piezoelectric vibration piece 32 is formed, for example, by processing crystal being a piezoelectric material to be a tuning-fork type. In this case, cutting from the monocrystals of crystal is done in such a manner that the X axis of FIG. 3 will be an electrical axis, the Y axis will be a mechanical axis, and the Z axis will be an optical axis. At the time of such cutting is done from the monocrystals of crystal, in the orthogonal coordinates system structured by the above-described X, Y and Z axes, an XY plane structured by the X and Y axes is formed by tilting about -5 to +5 degrees in a counterclockwise direction about the X axis.

[0050]

In FIG. 3, under such a condition, the piezoelectric vibration piece 32 is provided with a pair of vibration arms 34 and 35 horizontally extending from the base section 51 as described in the foregoing. In the present embodiment, the piezoelectric vibration piece 32 includes, in the vicinity of the base end sections of the vibration arms 34 and 35 of the base section 51, constriction sections or notch sections 48 and 48 are formed by expanding or contracting the width of the base section 51. By including such notch sections 48 and 48, in the piezoelectric vibration piece 32, no vibration is transferred from the vibration arms 34 and 35 to the

side of the base section 51.

[0051]

The vibration arms 34 and 35 are provided with grooves 44 and 44, respectively, extending in the length direction. These grooves 44 and 44 are, as shown in FIG. 4, formed on the surface and back sides of each vibration arm 34. Although not shown in FIG. 4, the groove formed to the vibration arm 35 has the same structure. In FIG. 4, the total length from one end section M1 to the other end section M2 in the length direction of the groove 44 is denoted by LA.

[0052]

Further, in the vicinity of the both end sections in the width direction of the end section (left end section in FIG. 2) of the base section 51 of the piezoelectric vibration piece 32, as already described above, formed are the extraction electrodes 33 and 33 for connection with the electrode sections 31 and 31 of the package 36. The extraction electrodes 33 and 33 are both provided to the surface and back sides of the base section 51 of the piezoelectric vibration piece 32. Such extraction electrodes 33 and 33 are connected to excitation electrodes, not shown, provided in the grooves 44 and 44 of the vibration arms 34 and 35. The manner of providing such excitation electrodes is the same as the conventional, and thus is not described.

[0053]

Next, the structure of the grooves 44 and 44 provided to the vibration arms 34 and 35 is described. Those grooves have the same

structure for each of the vibration arms 34 and 35. Thus, by showing either groove in FIG. 3 and 4, the comprehensive relationship between the vibration arms and grooves is described, for example.

[0054]

The arm width W1 of the piezoelectric vibration piece 32 is, for example, in a range from 50  $\mu\text{m}$  to 150  $\mu\text{m}$ . With respect to the thickness D1 of the vibration arm 34 of the piezoelectric vibration piece 32, the groove depth D2 of the groove 44 of FIG. 4 is set so as to be 30 percent or more but less than 50 percent of D1.

[0055]

The groove width W2 of the groove 44 is, preferably, set so as to be 40 percent or more of the arm width W1 of the vibration arm 35, and more preferably, 70 percent or more.

[0056]

Moreover, as shown in FIG. 3, the material structuring the vibration arm 34 (in this embodiment, "crystal material") is separated into two parts of 34a and 34b by the groove 44 provided to the vibration arm 34. AS shown in FIG. 4, the bottom section 46 is integrally formed. Thus, the groove 44 is a groove with a bottom, and not penetrating therethrough.

[0057]

Furthermore, as shown in FIG. 3, the grooves 44 and 44 of the vibration arms 34 and 35 are provided, respectively, with support sections 45 and 45 both of a sidebar type, for example. To be specific, to the parts 34a and 34b formed as a result of separation

by the groove 44 of the vibration arm 34, the support section 45 is integrally connected.

[0058]

As shown in FIG. 4, the support section 45 is formed to be integrated with the bottom section 46 of the groove 44, and the resulting integral sections 45a and 45b both being integrated with the groove bottom section 46 of the support section 45 are formed so as to be thicker than the opening end section of at least of the groove 44 of the support section 45. Specifically, the integral section 45a where the support section 45 and the bottom section 46 are integrated is extending towards the bottom section 46, looking like a bell-bottom.

[0059]

In this embodiment, as shown in FIG. 4, the groove 44 and the support section 45 have one-to-one relationship, and the distance L1 from one end section M1 of the groove 44 to the center O of the support section 45 is equalized to the distance L2 from the center O of the support section 45 to the other end section M2 of the groove 44.

[0060]

With such a structure, the total length LA of the groove 44 is divided into two by the support section 45, and when the piezoelectric vibration piece 32 is driven, the bending vibration is equally divided by the support section 45. Thus, deformation in the twisting direction is cancelled out, preventing twisting deformation

as a whole.

[0061]

Further, the support section 45 may be plurally provided as long as it fits in the range of the total length LA of the groove 44. Thereby, the vibration arm 34 is increased in rigidity, and the CI value is also increased. Accordingly, in the allowance range for increase of the CI value, by increasing the number of the support sections 45, the rigidity of the vibration arm 34 can be increased to a greater degree.

[0062]

The present embodiment is structured as above, and as shown in FIG. 4, the grooves 44 and 44 formed to the vibration arms 34 and 35, respectively, of the piezoelectric vibration piece 32 are both grooves with a bottom. Thus, in comparison with a case of forming a penetrated groove to both the vibration arms 34 and 35, these vibration arms 34 and 35 are provided with the better rigidity.

[0063]

What is more, in FIGS. 3 and 4, the grooves 44 are each provided with the support section 45. Being integrated with the bottom section 46 of the groove 44, the support section 45 supports the materials 34a and 34b structuring the vibration arm 34 separated by the groove 44 in the width direction so that deformation is prevented from occurring. Accordingly, the vibration arm 34 can be enforced in rigidity in the twisting direction thereof.

[0064]

As such, with the piezoelectric vibration piece 32, there is no need to provide the support section 45 plurally to the groove 44 of the vibration arm 34 or 35. Thus, the CI value is not increased, appropriate vibration can be realized by ensuring the rigidity along the almost entire length of the vibration arms with the movement of the vibration arms 34 and 35 suppressed in the vertical direction.

[0065]

Further, as described by referring to FIG. 4, the support section 45 includes the integral sections 45a and 45b being thicker towards the bottom section 46 of the groove 44. Thus, the support section 45 is securely connected especially to the bottom section 46 of the groove 44. Accordingly, in the piezoelectric vibration piece 32, with the support section 45 being securely fixed to the bottom section 46 of the groove 44, the deformation force in the twisting direction of the vibration arm 34 is effectively countered with. In such a manner, the deformation in the twisting direction can be prevented in a more effective manner.

[0066]

Further, as already described in the foregoing, the arm width  $W1$  of the vibration arms 34 and 35 of the piezoelectric vibration piece 32 is, for example, in a range from  $50\text{ }\mu\text{m}$  to  $150\text{ }\mu\text{m}$ . The groove depth  $D2$  of the groove 44 is set so as to be 30 percent or more but less than 50 percent of the material thickness of the vibration arms 34 and 35. With such a structure, the CI value can be low enough.



[0067]

In this case, if the depth D2 of the groove 44 is less than 30 percent of the material thickness D1 of the vibration arm 34, the advantage of reduction of the CI value cannot be sufficiently obtained, and sometimes the CI value cannot be practical. With an exemplary tuning-fork vibrator of 32.768 kHz having the arm width of 100  $\mu\text{m}$ , the CI value is about 100 k $\Omega$  being close to a limitation of practical range even if the groove depth is 30  $\mu\text{m}$  (30 percent of the material thickness), and the groove width is 70 $\mu\text{m}$  (70 percent of the arm width, and with this dimension, the CI value is not reduced that much even if the groove width is widened more).

[0068]

Moreover, the depth D2 of the groove 44 exceeds 50 percent of the material thickness D1 of the vibration arm 34, it becomes impossible to form the groove 44 respectively to the surface and back sides of the vibration arm.

[0069]

As shown in FIG. 3, the groove width W2 of the groove 44 of the piezoelectric vibration piece 32 is set so as to be 40 percent or more of the arm width W1 of the vibration arm. In this case, if the groove width W2 of the groove 44 is less than 40 percent of the arm width W1 of the vibration arm, the advantage of reduction of the CI value cannot be sufficiently obtained, and thus the resulting CI value cannot be practical. With an exemplary tuning-fork vibrator of 32.768 kHz having the arm width of 100  $\mu\text{m}$ , the CI value is about 100

$k\Omega$  being close to a limitation of practical range when the groove depth is 45  $\mu\text{m}$  (45 percent of the material thickness, and increasing the groove depth any further may penetrate the material, and is difficult to manufacture), and the groove width is 40 $\mu\text{m}$  (40 percent of the arm width).

[0070]

Further, preferably, in the piezoelectric vibration piece 32, the groove width  $W2$  of the groove 44 can be 70 percent or more of the arm width  $W1$  of the vibration arm. In this manner, the CI value will be in the range of maximizing the reduction effects thereof. Here, if the groove width  $W2$  of the groove 44 is 100 percent of the arm width  $W1$  of the vibration arm, needless to say, this does not allow groove formation.

[0071]

FIGS. 5 to 7 are graphs as a result of simulation of the relationship between the frequency change rate and the current based on the electric field formed to the piezoelectric vibration piece at the time of driving.

[0072]

With the piezoelectric vibration piece of a so-called tuning-fork type, assuming that  $\Delta f/f$  denotes a frequency change rate, and  $I^2$  denotes a square value of the current flowing to the piezoelectric vibration piece, generally, the relationship of the following equation is generally established.

[0073]

$\Delta f/f = k_1 \cdot I^2 + k_2 \cdot I^2$  ..... equation 2. Herein,  $k_1$  is a constant (becomes a positive value) determined as an elastic body when the piezoelectric vibration piece vibrates in the horizontal direction (x direction of FIG. 13).  $k_2$  is a constant (becomes a negative value) determined as an elastic body when the piezoelectric vibration piece vibrates in the vertical direction (z direction of FIG. 13).

[0074]

FIG. 5 shows the property of the piezoelectric vibration piece of a case where no groove is formed to the piezoelectric vibration piece, that is, for example, the grooves 44 and 44 are not provided to such a piezoelectric vibration piece 32 as shown in FIG. 3. In such a case,  $\Delta f/f$  denotes a positive value, and the vibration frequency varies in the range from 3 to 5 ppm.

[0075]

FIG. 6 shows the property of the piezoelectric vibration piece of a case where the piezoelectric vibration piece is formed only with a groove, that is, the piezoelectric vibration piece 32 of FIG. 3 is provided with the grooves 44 and 44 but not with the support sections 45 and 45, for example. In such a case, due to the reasons described by referring to FIG. 13, the vertical vibration component being  $k_2$  becomes larger,  $\Delta f/f$  indicates a negative value, and the vibration frequency varies in the range from -8 to -4 ppm.

[0076]

FIG. 7 shows the property of the piezoelectric vibration piece 32 of the present embodiment, that is, of the piezoelectric vibration

piece in which the vibration arms 34 and 35 are formed with the grooves 44 and 44, and the support section 45 is formed in the groove 44. As shown in the drawing, compared with FIG. 6, it is understood that the vertical vibration component being  $k_2$  is considerably reduced, and the variation ratio of the vibration frequency being  $\Delta f/f$  fits in the range of about -1 to +2.

[0077]

FIGS. 8 and 9 are both graphs showing the interrelation between the CI value and the temperature property for the piezoelectric vibration piece of a so-called tuning-fork type, and shows the relationship between the change of CI value and the maximum temperature described by referring to FIGS. 14 and 15.

[0078]

FIG. 8 is a graph showing the CI value - temperature property of a case where the vibration arm is formed with a groove but not with a support section, and FIG. 9 is a graph showing the CI value - temperature property of the piezoelectric vibration piece 32 of the present embodiment.

[0079]

In the case of FIG. 8, as the CI value changes (increased), the maximum temperature shifts to the negative side. On the other hand, in the case of the present embodiment of FIG. 9, the maximum temperature does not shift even if the CI value changes.

[0080]

That is, as FIG. 8, the reason why the interrelation is

observed between the CI value and the maximum temperature is that, when the vibration arm is formed with a groove but not with a support section, the vertical vibration component of the vibration arm becomes unstable. As shown in FIG. 9, if the vibration arm is formed with both a groove and a support section, the maximum temperature can be stable without depending on the CI value as shown in FIG. 9.

[0081]

FIG. 10 is a diagram showing the schematic structure of a portable digital phone unit as an example of the electric equipment using the piezoelectric device according to the above-described embodiment of the present invention.

[0082]

In the drawing, included are a microphone 308 for receiving the voice of a caller, and a speaker 309 for converting the received content into a voice output. Further, a CPU (Central Processing Unit) 301 being an integrated circuit and the like as a control section connected to a modulation and demodulation sections for a transmission and reception signal is also included.

[0083]

Other than modulation and demodulation of a transmission and reception signal, the CPU 301 controls an information input/output section 302 structured by an LCD as an image display section, and operation keys and others for information input, and information storage means 303 structured by RAM, ROM, and others. Thus, to the CPU 301, the piezoelectric device 30 is attached, and the output

frequency thereof is used as a clock signal matching the control details by a predetermined frequency divider (not shown) incorporated in the CPU 301. The piezoelectric device 30 attached to the CPU 301 is not necessarily be a single unit such as the piezoelectric device 30, but may be an oscillator as a result of combining the piezoelectric device 30 and the like, and any predetermine frequency divider and the like.

[0084]

Further, the CPU 301 is connected to a temperature-compensated crystal oscillator (TCXO) 305, and the temperature-compensated crystal oscillator 305 is connected to both a transmission section 307 and a reception section 306. With such a structure, even if a basic clock from the CPU 301 varies responding to the change of the environment temperature, it is corrected by the temperature-compensated crystal oscillator 305 to be supplied to the transmission section 307 and the reception section 306.

[0085]

As such, by using the piezoelectric vibration piece 32 and the piezoelectric device 30 using the same according to the present embodiment described above to such electric equipment as portable digital phone unit 300 including a control section, appropriate vibration can be realized without increasing the CI value by ensuring the rigidity along the almost entire length of the vibration arm with the movement of the vibration arm in the vertical direction suppressed. Thereby, a correct clock signal can be generated.

[0086]

The present invention is not restricted to the above embodiments. Each structure of the embodiments can be combined together or omitted as appropriate, or combined with any other structures that are not shown.

[0087]

Further, this invention is applicable to every piezoelectric device no matter what name they carry such as a piezoelectric vibrator, a piezoelectric oscillator, and the like as long as a piezoelectric vibration piece is accommodated in a package, a metal tubular case and the like.

[0088]

Still further, in the above embodiment, the package is in the shape of box made of a piezoelectric material. This is not restrictive, and the present invention is applicable to the ones including any type of package or case as long as the package is at least partially light transmittable.

[0089]

The full disclosure text of Japanese Patent filed on December 17, 2002, with the application number 2002-365531 accompanies the Specification as reference.